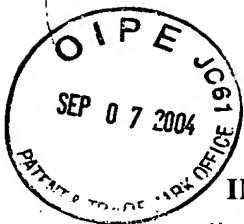


2827
JFW



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Sung-Fei WANG, et al.

Serial No.: 10/087,432

Group No.: 2827

Filed: March 1, 2002

Examiner.: J.M. Mitchell

For: STACKED SEMICONDUCTOR CHIP PACKAGE

Attorney Docket No.: U 013887-9

Commissioner for Patents
P.O. BOX 1450
Alexandria, Va. 22313

Sir:

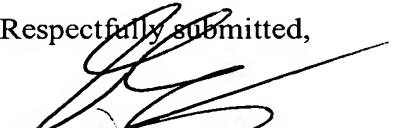
REQUEST FOR NEW ACTION

The Action of August 25, 2004 issued from Group 2813, which should have web-posted references in June.

However, the attached copy of Patent Application Information retrieval for September 1, 2004, shows that it did not.

Therefore, a new Action with references is requested.

Respectfully submitted,



WILLIAM R. EVANS
LADAS & PARRY
26 WEST 61ST STREET
NEW YORK, NY 10023
REG. NO.: 35858 (212) 708-1930

CERTIFICATE OF MAILING (37 CFR 1.8a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal on the date shown below with sufficient postage as first class mail in an envelope addressed to the: Commissioner for Patents, P.O. BOX 1450, Alexandria, Va. 22313

Date: September 3, 2004

WILLIAM R. EVANS
(Type or print name of person mailing paper)



(Signature of person mailing paper)

United States Patent and Trademark Office

Home Site Index Search Guides Contacts eBusiness eBiz alerts News Help

PATENT APPLICATION INFORMATION RETRIEVAL

Search results as of: 9-1-2004::15:58:31 E.T.

Search results for application number: 10/087,432

| | | | |
|----------------------|---------------------------------------|----------------------------|-------------------------|
| | 10/087,432 | | - |
| | 03-01-2002 | | Non Final Action Mailed |
| | Utility | | 08-25-2004 |
| Examiner Name: | MITCHELL, JAMES M | | ELECTRONIC |
| Group Art Unit: | 2813 | Location Date: | - |
| Confirmation Number: | 3547 | Earliest Publication No: | US 2002-0125580 A1 |
| | U 013887-9 | Earliest Publication Date: | 09-12-2002 |
| | 257/777 | | - |
| | Sung-Fei Wang, Nantze Kaohsiung, (TW) | | - |
| | Stacked semiconductor chip package | | |

Search Options

| |
|---------------------|
| Foreign Priority |
| Image File Wrapper |
| Published Documents |

| File History | |
|--------------|--|
| Date | Contents Description |
| 08-25-2004 | Mail Non-Final Rejection |
| 08-23-2004 | Non-Final Rejection |
| 08-16-2004 | Case Docketed to Examiner in GAU |
| 06-18-2004 | Date Forwarded to Examiner |
| 06-04-2004 | Response after Non-Final Action |
| 06-04-2004 | Workflow incoming amendment IFW |
| 03-01-2004 | Mail Non-Final Rejection |
| 02-17-2004 | Non-Final Rejection |
| 11-19-2003 | IFW Amended case processing Complete |
| 11-18-2003 | Date Forwarded to Examiner |
| 11-03-2003 | Response after Non-Final Action |
| 08-11-2003 | Miscellaneous Incoming Letter |
| 07-30-2003 | Mail Non-Final Rejection |
| 07-28-2003 | Non-Final Rejection |
| 05-16-2003 | Date Forwarded to Examiner |
| 03-20-2003 | Response after Non-Final Action |
| 12-17-2002 | Mail Non-Final Rejection |
| 12-16-2002 | Non-Final Rejection |
| 04-29-2002 | New or Additional Drawing Filed |
| 09-26-2002 | Date Forwarded to Examiner |
| 09-10-2002 | Response after Non-Final Action |
| 05-03-2002 | Affidavit(s) (Rule 131 or 132) or Exhibit(s) Received |
| 05-03-2002 | Preliminary Amendment |
| 06-06-2002 | Mail Non-Final Rejection |
| 06-06-2002 | Non-Final Rejection |
| 05-03-2002 | Substitute Specification Filed |
| 05-03-2002 | Request for Foreign Priority (Priority Papers May Be Included) |
| 05-23-2002 | Case Docketed to Examiner in GAU |
| 04-29-2002 | Workflow - Drawings Received at Contractor |
| 04-29-2002 | Workflow - Drawings Sent to Contractor |
| 04-11-2002 | Application Dispatched from OIPE |
| 04-09-2002 | Application Is Now Complete |
| 03-19-2002 | IFW Scan & PACR Auto Security Review |
| 03-01-2002 | Initial Exam Team nn |